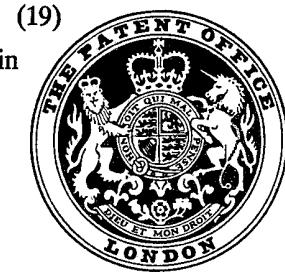


1 598 364

- (21) Application No. 558/78 (22) Filed 6 Jan. 1978
 (31) Convention Application No. 757706 (32) Filed 7 Jan. 1977 in
 (33) United States of America (US)
 (44) Complete Specification Published 16 Sep. 1981
 (51) INT. CL.³ B32B 15/08
 (52) Index at Acceptance
 B5N 1508
 (72) Inventors: VIRGIL BENSON KURFMAN
 RAYMOND EARL GRANSDEN, JR



(54) HIGHLY REFLECTIVE MULTILAYER METAL/POLYMER COMPOSITES

5 (71) We, THE DOW CHEMICAL COMPANY, a Corporation organised and existing under the laws of the State of Delaware, United States of America, of
 10 Midland, County of Midland, State of Michigan, United States of America, do hereby declare the invention, for which we pray that a patent may be granted to us, and the method by which it is to be performed, to be particularly described in and by the following statement:-

15 This invention relates to metal/polymer composites and to articles formed therefrom.

20 Metallized plastics articles prepared by applying a metal to a plastics material by vacuum deposition, electrolytic or electroless deposition, foil lamination or similar metallizing techniques are well known. Such articles are widely employed for decorative purposes, particularly the metallized films which are quite flexible and can be shaped to some extent to conform to various contours.

25 Unfortunately, the degree to which such conventional metallized films or sheets or other articles can be shaped without rupture and/or separation of the metal from the polymer is generally limited to those shaping procedures involving localized dimensional changes of less than 25 percent in one direction and less than 20 percent (based on area of the film) if the dimensional changes are in two directions. The visual effect of stretching the metallized polymer beyond this limit is a noticeable loss of specular reflectance at the points of excessive elongation. The resulting article has a marred appearance and diminished utility in decorative, electrical and packaging applications.

30 As a result of the loss of barrier properties caused by actually stretching the metallized polymer beyond the 20 percent limit where the dimensional change is in two directions (based on area of the film), the use of such

metallized polymers in many packaging applications is severely reduced, particularly where high barrier to vapor transmission is critical. Likewise, the corresponding loss of electrical conductivity reduces the suitable 50 electrical applications to those involving minimal dimensional change.

55 In addition, the aforementioned limitation on the amount of dimensional change of the metallized polymers significantly hinders their use in the manufacture of reflective parts (often called bright work) for automobiles and other vehicles of transportation as well as for household appliances. Such reflective parts often require biaxial extension such that the stretched article occupies an area more than 50 percent greater than the area of the article prior to stretching.

60 In view of the aforementioned needs for novel highly extendable, multilayer metal/polymer composites and the deficiencies of existing metallized polymer articles in this regard, the present invention provides a multilayer, metal/organic polymer composite that exhibits excellent specular reflectance, electroconductivity and barrier to vapor transmission after substantial dimensional change.

65 In one aspect the present invention provides a formable metal/organic polymer composite comprising a layer of a normally solid thermoplastic polymer (as hereinafter defined) and a layer of a normally solid soft metal intimately adhered to at least one surface of the polymer layer, said soft metal melting at a temperature or over a range of temperatures that is from 80 to 135 percent of the forming temperature of the thermoplastic polymer, said temperatures being in degrees K, and being indium or an alloy of two or more metals, other than a lead alloy, comprising at least 50 weight percent of a first metal and at least 5 weight percent of at least one second metal, the said composite

50

55

60

65

70

75

80

85

90

- being capable, when subjected to a forming operation, of undergoing a cumulative surface dimensional change of at least 20 percent.
- 5 In a further aspect of the present invention provides a method of making a metal/organic polymer composite of the present invention, which method comprises intimately adhering together a layer of a normally solid, soft metal as defined above and at least one surface of a layer of a normally solid, formable thermoplastic polymer as hereinafter defined.
- 10 In yet a further aspect the present invention provides a method of making a formed metal/organic polymer composite, which method comprises subjecting a formable metal/organic polymer composite of the invention to a forming operation during which at least a portion of the composite is modified by its undergoing a cumulative surface dimensional change of at least 20 percent.
- 15 By the term "formed metal/organic polymer composite" as used herein is meant the composite has been formed such that at least a portion undergoes a cumulative surface dimensional change of at least 20 percent, preferably by extending at least a portion of the multilayer composite to an area that is at least 30 percent greater than the area of the portion before forming, without rupturing either the metal layer or the polymer layer. In this instance, it is understood that the presence of pinholes, i.e. those having an average diameter of less than 1 micrometer, which are often formed during metallizing and/or the extension process, can be tolerated. Such pinholes do not noticeably reduce specular brightness, electroconductivity or barrier properties.
- 20 Surprisingly, the formed metal/organic polymer composite of this invention exhibits specular brightness, barrier and/or electrical continuity that are nearly the same as those of the composite prior to forming. In fact, the metal/organic polymer composites of this invention exhibit electrical resistivities of less than 100 ohms/square even after forming, preferably less than 10 ohms/square. In contrast, the metal/polymer composites conventional to the art exhibit electrical resistivities greater than 1000 ohms/square after similar forming. Moreover, the metal layer of the formed composite remains strongly adhered to the polymer layer even though forming was carried out at temperatures at which most of the metal is in the melted or liquidus state and the polymer layer is heat plastified or nearly so.
- 25 As a result of this surprising capability the metal/organic polymer composites are usefully formed into articles such as bumpers and other reflective parts for automobiles and other vehicles of transportation, and
- 30
- 35
- 40
- 45
- 50
- 55
- 60
- 65
- 70
- 75
- 80
- 85
- 90
- 95
- 100
- 105
- 110
- 115
- 120
- 125
- 130
- housings and decorative parts for appliances with minimal, if any loss, of brightness, barrier properties and electroconductivity. In addition, these formed composites are usefully employed in electrical applications and as plastics containers exhibiting a high degree of barrier properties to atmospheric gases. Particularly surprising is the fact that metal/organic polymer composites of this invention, wherein the polymer layer is polyolefin, exhibit a barrier to oxygen superior to that of conventional metal/polyolefin composites wherein the metal layer is aluminum, silver or copper. For purposes of this invention, "high barrier" means that the formed composite exhibits a permeance to atmospheric gases essentially equivalent to metal foil/polymer laminate films, e.g., an oxygen transmission rate less than about 0.1 cc through a 1 mil thick film having an area of 645 square centimeters (100 square inches) when exposed to a pressure difference of 1 atmosphere at a temperature of 25°C (298°K) over a 24 hour period (hereinafter abbreviated cc/645 cm²/mil/day/ atm). Because the formed composites of this invention can withstand wet environments, they are especially desirable for the packaging of oxygen-sensitive wet foods such as, for example, apple-sauce, fruit, or catsup as well as dry foods such as, for example, coffee or potato chips.
- 144
- 145
- 146
- 147
- 148
- 149
- 150
- 151
- 152
- 153
- 154
- 155
- 156
- 157
- 158
- 159
- 160
- 161
- 162
- 163
- 164
- 165
- 166
- 167
- 168
- 169
- 170
- 171
- 172
- 173
- 174
- 175
- 176
- 177
- 178
- 179
- 180
- 181
- 182
- 183
- 184
- 185
- 186
- 187
- 188
- 189
- 190
- 191
- 192
- 193
- 194
- 195
- 196
- 197
- 198
- 199
- 200
- 201
- 202
- 203
- 204
- 205
- 206
- 207
- 208
- 209
- 210
- 211
- 212
- 213
- 214
- 215
- 216
- 217
- 218
- 219
- 220
- 221
- 222
- 223
- 224
- 225
- 226
- 227
- 228
- 229
- 230
- 231
- 232
- 233
- 234
- 235
- 236
- 237
- 238
- 239
- 240
- 241
- 242
- 243
- 244
- 245
- 246
- 247
- 248
- 249
- 250
- 251
- 252
- 253
- 254
- 255
- 256
- 257
- 258
- 259
- 260
- 261
- 262
- 263
- 264
- 265
- 266
- 267
- 268
- 269
- 270
- 271
- 272
- 273
- 274
- 275
- 276
- 277
- 278
- 279
- 280
- 281
- 282
- 283
- 284
- 285
- 286
- 287
- 288
- 289
- 290
- 291
- 292
- 293
- 294
- 295
- 296
- 297
- 298
- 299
- 300
- 301
- 302
- 303
- 304
- 305
- 306
- 307
- 308
- 309
- 310
- 311
- 312
- 313
- 314
- 315
- 316
- 317
- 318
- 319
- 320
- 321
- 322
- 323
- 324
- 325
- 326
- 327
- 328
- 329
- 330
- 331
- 332
- 333
- 334
- 335
- 336
- 337
- 338
- 339
- 340
- 341
- 342
- 343
- 344
- 345
- 346
- 347
- 348
- 349
- 350
- 351
- 352
- 353
- 354
- 355
- 356
- 357
- 358
- 359
- 360
- 361
- 362
- 363
- 364
- 365
- 366
- 367
- 368
- 369
- 370
- 371
- 372
- 373
- 374
- 375
- 376
- 377
- 378
- 379
- 380
- 381
- 382
- 383
- 384
- 385
- 386
- 387
- 388
- 389
- 390
- 391
- 392
- 393
- 394
- 395
- 396
- 397
- 398
- 399
- 400
- 401
- 402
- 403
- 404
- 405
- 406
- 407
- 408
- 409
- 410
- 411
- 412
- 413
- 414
- 415
- 416
- 417
- 418
- 419
- 420
- 421
- 422
- 423
- 424
- 425
- 426
- 427
- 428
- 429
- 430
- 431
- 432
- 433
- 434
- 435
- 436
- 437
- 438
- 439
- 440
- 441
- 442
- 443
- 444
- 445
- 446
- 447
- 448
- 449
- 450
- 451
- 452
- 453
- 454
- 455
- 456
- 457
- 458
- 459
- 460
- 461
- 462
- 463
- 464
- 465
- 466
- 467
- 468
- 469
- 470
- 471
- 472
- 473
- 474
- 475
- 476
- 477
- 478
- 479
- 480
- 481
- 482
- 483
- 484
- 485
- 486
- 487
- 488
- 489
- 490
- 491
- 492
- 493
- 494
- 495
- 496
- 497
- 498
- 499
- 500
- 501
- 502
- 503
- 504
- 505
- 506
- 507
- 508
- 509
- 510
- 511
- 512
- 513
- 514
- 515
- 516
- 517
- 518
- 519
- 520
- 521
- 522
- 523
- 524
- 525
- 526
- 527
- 528
- 529
- 530
- 531
- 532
- 533
- 534
- 535
- 536
- 537
- 538
- 539
- 540
- 541
- 542
- 543
- 544
- 545
- 546
- 547
- 548
- 549
- 550
- 551
- 552
- 553
- 554
- 555
- 556
- 557
- 558
- 559
- 560
- 561
- 562
- 563
- 564
- 565
- 566
- 567
- 568
- 569
- 570
- 571
- 572
- 573
- 574
- 575
- 576
- 577
- 578
- 579
- 580
- 581
- 582
- 583
- 584
- 585
- 586
- 587
- 588
- 589
- 590
- 591
- 592
- 593
- 594
- 595
- 596
- 597
- 598
- 599
- 600
- 601
- 602
- 603
- 604
- 605
- 606
- 607
- 608
- 609
- 610
- 611
- 612
- 613
- 614
- 615
- 616
- 617
- 618
- 619
- 620
- 621
- 622
- 623
- 624
- 625
- 626
- 627
- 628
- 629
- 630
- 631
- 632
- 633
- 634
- 635
- 636
- 637
- 638
- 639
- 640
- 641
- 642
- 643
- 644
- 645
- 646
- 647
- 648
- 649
- 650
- 651
- 652
- 653
- 654
- 655
- 656
- 657
- 658
- 659
- 660
- 661
- 662
- 663
- 664
- 665
- 666
- 667
- 668
- 669
- 670
- 671
- 672
- 673
- 674
- 675
- 676
- 677
- 678
- 679
- 680
- 681
- 682
- 683
- 684
- 685
- 686
- 687
- 688
- 689
- 690
- 691
- 692
- 693
- 694
- 695
- 696
- 697
- 698
- 699
- 700
- 701
- 702
- 703
- 704
- 705
- 706
- 707
- 708
- 709
- 710
- 711
- 712
- 713
- 714
- 715
- 716
- 717
- 718
- 719
- 720
- 721
- 722
- 723
- 724
- 725
- 726
- 727
- 728
- 729
- 730
- 731
- 732
- 733
- 734
- 735
- 736
- 737
- 738
- 739
- 740
- 741
- 742
- 743
- 744
- 745
- 746
- 747
- 748
- 749
- 750
- 751
- 752
- 753
- 754
- 755
- 756
- 757
- 758
- 759
- 760
- 761
- 762
- 763
- 764
- 765
- 766
- 767
- 768
- 769
- 770
- 771
- 772
- 773
- 774
- 775
- 776
- 777
- 778
- 779
- 780
- 781
- 782
- 783
- 784
- 785
- 786
- 787
- 788
- 789
- 790
- 791
- 792
- 793
- 794
- 795
- 796
- 797
- 798
- 799
- 800
- 801
- 802
- 803
- 804
- 805
- 806
- 807
- 808
- 809
- 810
- 811
- 812
- 813
- 814
- 815
- 816
- 817
- 818
- 819
- 820
- 821
- 822
- 823
- 824
- 825
- 826
- 827
- 828
- 829
- 830
- 831
- 832
- 833
- 834
- 835
- 836
- 837
- 838
- 839
- 840
- 841
- 842
- 843
- 844
- 845
- 846
- 847
- 848
- 849
- 850
- 851
- 852
- 853
- 854
- 855
- 856
- 857
- 858
- 859
- 860
- 861
- 862
- 863
- 864
- 865
- 866
- 867
- 868
- 869
- 870
- 871
- 872
- 873
- 874
- 875
- 876
- 877
- 878
- 879
- 880
- 881
- 882
- 883
- 884
- 885
- 886
- 887
- 888
- 889
- 890
- 891
- 892
- 893
- 894
- 895
- 896
- 897
- 898
- 899
- 900
- 901
- 902
- 903
- 904
- 905
- 906
- 907
- 908
- 909
- 910
- 911
- 912
- 913
- 914
- 915
- 916
- 917
- 918
- 919
- 920
- 921
- 922
- 923
- 924
- 925
- 926
- 927
- 928
- 929
- 930
- 931
- 932
- 933
- 934
- 935
- 936
- 937
- 938
- 939
- 940
- 941
- 942
- 943
- 944
- 945
- 946
- 947
- 948
- 949
- 950
- 951
- 952
- 953
- 954
- 955
- 956
- 957
- 958
- 959
- 960
- 961
- 962
- 963
- 964
- 965
- 966
- 967
- 968
- 969
- 970
- 971
- 972
- 973
- 974
- 975
- 976
- 977
- 978
- 979
- 980
- 981
- 982
- 983
- 984
- 985
- 986
- 987
- 988
- 989
- 990
- 991
- 992
- 993
- 994
- 995
- 996
- 997
- 998
- 999
- 1000

- resins that may be softened by heat and then regain their original properties upon cooling. Also included within this term are thermosetting resins in the B stage, i.e., that stage prior to crosslinking wherein the resin exhibits the heat plastification characteristics of a thermoplastic resin. In some preferred embodiments, the thermoplastic polymers are also generally transparent. 5
- Because of their lower cost and superior structural properties, polymers of particular interest in the practice of this invention include engineering plastics such as polystyrene, styrene/acrylonitrile copolymers, copolymers containing polymerized styrene, acrylonitrile and butadiene (often called ABS polymers) styrene/butadiene copolymers, rubber modified styrene polymers, styrene/maleic anhydride copolymers and similar polymers of monovinylidene aromatic carbocyclic monomers; polycarbonates including those made from phosgene and bisphenol A and/or phenolphthalein; polyesters such as polyethylene terephthalate; acrylic resins such as poly(methyl methacrylate); polyacetyl resins such as polyformaldehyde resin; nitrile resins such as polyacrylonitrile and other polymers of α,β -ethylenically unsaturated nitriles such as acrylonitrile/methyl methacrylate copolymers; polyamides such as nylon; polyolefins such as polyethylene and polypropylene; polyvinyl halides such as polyvinylchloride and vinylidene chloride homopolymers and copolymers; polyurethanes; polyallomers; polyphenylene oxides; polymers of fluorinated olefins such as polytetrafluoroethylene; and other normally solid polymers which can be formed while in the solid state into the desired shape by conventional forming techniques, such as for example, cold drawing, vacuum drawing, drape molding, pressure thermoforming, or scrapless thermoforming procedures. Especially preferred, particularly for polymer layers which must exhibit significant abrasion resistance as well as a high degree of transparency are the polycarbonates, particularly those derived from the bis(4-hydroxyphenol)alkylidenes (often called bisphenol A types) and those derived from the combination of such bisphenol A type diols with phenolphthalein type diols. It is understood that the polymer layer of the multilayered composite may also contain one or more additaments such as, for example, dyes, light stabilizers, reinforcement fillers and fibers, pigments, or carbon black. 10
- The thickness of the polymer layer(s) of the multilayer composite is not particularly critical. Therefore, the polymer layer is of suitable thickness if it can be formed into a continuous layer which will have the necessary strength to survive the conditions normal to its intended use. Accordingly, such 15
- properties will often be abrasion resistance, corrosion resistance, tensile or impact strength and other physical properties which will be evident to those skilled in the art of fabricating polymers and metallized polymers. Usually, the thickness of the polymer layer(s) is in the range from 2 to 10,000 micrometers, preferably from 10 to 500 micrometers. 20
- The soft metal layer(s) of the multilayer composite which imparts specular reflectance, as well as high barrier and electroconductivity when such are desired, preferably comprises a soft metal melting at a temperature or over a range of temperatures that is from 90 to 110 percent of the forming temperature of the thermoplastic polymer, said temperatures being in $^{\circ}\text{K}$. 25
- Preferred soft metals can be further characterised as containing at least 50 weight percent, more advantageously from 60 to 87 weight percent of a first metal having a melting point below 450°C (723°K) and at least 5 weight percent, more advantageously from 10 to 47 weight percent of a second metal also having a melting point below 450°C (723°K). Especially preferred are alloys which additionally contain at least 0.1 weight percent, most advantageously from 3 to 20 weight percent, of a metal having a melting point above 450°C (723°K). 30
- As well as indium, examples of suitable soft metals are alloys of any two or more of the following metals: cadmium, indium, tin, antimony, zinc, bismuth, and silver. In addition, other metals may be present in the alloys so long as the melting range of the alloy is within the prescribed range of 80 to 135 percent of the forming temperature. Representative of such alloys are those containing 50 weight percent of antimony, indium, bismuth, tin, zinc or cadmium; from 0 to 10 weight percent of one or more metals such as manganese, nickel, iron, and other metals having melting points greater than 1100°C (1373°K); and a remaining amount of one or more of silver, copper, gold, aluminium and magnesium. Of special interest are alloys having a solidus temperature less than 650°K , preferably less than 548°K , and containing at least 60 weight percent of indium, bismuth, tin, zinc, cadmium and antimony and not more than 95, preferably not more than 90 and most preferably not more than 80, weight percent of any one metal. 35
- Preferred are alloys of tin, silver and indium, alloys of zinc, cadmium and indium, alloys of indium and silver, alloys of tin and cadmium, alloys of silver and indium and alloys of magnesium and aluminium. Of the aforementioned alloys, alloys of tin and bismuth are more preferred with alloys of tin, bismuth and copper being most preferred. 40
- 45
- 50
- 55
- 60
- 65

5	Illustrative preferred alloys are (i) 50 percent tin, 30 percent bismuth, 20 percent copper; (ii) 80 percent tin, 15 percent bismuth, 5 percent copper; (iii) 75 percent tin, 20 percent copper, 5 percent silver; (iv) 75 percent tin, 25 percent silver; (v) 55 percent tin, 35 percent bismuth; 10 percent silver; and (vi) 84 percent tin, 12 percent bismuth, 4 percent copper.	70
10	It should be understood, however, that preference for the different alloys will vary depending on the end use. For example, alloys of tin and copper, alloys of tin and silver and alloys of tin, bismuth and copper show superior corrosion resistance compared to alloys of zinc and cadmium. Similarly, alloys of tin, bismuth and copper and alloys of tin and copper would be more acceptable in food packaging than would be more toxic alloys of tin.	75
15	Moreover, it is observed that preference for various alloys will vary with the different polymer layers used in the multilayer composite. For example, it is observed that the alloys of tin and copper, the alloys of tin and silver, the alloys of indium and silver, the alloys of tin, bismuth and copper, and the alloys of zinc and cadmium are preferred when the multilayer composite is to be formed at temperatures from 25°C (298°K) to 175°C (448°K) as in the case when the polymer layer consists essentially of polycarbonate.	80
20	In addition, it has been generally observed that the more concentrated alloys, i.e., those containing larger amounts, e.g., more than 20 weight percent (preferably 25 weight percent or more) of the minor components of the alloy, are generally more easily extended than the more dilute alloys, i.e., those containing very substantial amounts of the major component of the alloy and minimal amounts of the minor component or components. For example, an alloy of 75 weight percent tin and 25 weight percent silver is superior in regard to plastic character than an alloy of 90 percent tin and 10 percent silver. Also, an alloy of 50 percent tin and 50 percent indium exhibits extendibility characteristics superior to that of an alloy of 90 percent tin and 10 percent indium.	85
25	Also it is noted that alloys of tin, bismuth and a higher melting metal such as copper, silver, nickel, magnesium, gold, iron, chromium and manganese, particularly those containing (1) at least 8 weight percent each of tin and bismuth and (2) more bismuth than the higher melting metal, exhibit excellent adhesion and forming characteristics.	90
30	For example, composites employing these alloys may be formed at temperatures at which the polymer and most of the alloy melt without loss of adhesion or integrity (continuity of the metal layer). These multi-	95
35	layer composites exhibit superior vapor barrier characteristics and may be flexed a number of times without an apparent loss of continuity of the metal layer. Of the alloys of these highly adherent composites, alloys of particular interest consist essentially of from 25 to 90, preferably from 60 to 80, weight percent tin; from 8 to 60, preferably 8 to 30, most preferably 12 to 25, weight percent bismuth; and from 1 to 25, weight percent bismuth; and from 1 to 25, preferably 4 to 12, weight percent of higher melting metal, preferably copper or silver, providing that one of the metals tin or bismuth is present in an amount of at least 50 weight percent.	100
40	Since the normal thermoplastic polymers which will be utilized in the multilayer composites of the present invention are preferably formed at temperatures in the range from 25°C (298°K) to 200°C (473°K), preferably 100°C (373°K) to 200°C (473°K), it will be generally desirable that the indium or metal alloys advantageously employed in the practice of this invention will have melting points or melting point ranges within the range from 100°C (373°K) to 400°C (673°K), preferably from 130°C (403°K) to 275°C (548°K). For the purposes of this invention, the melting point of indium or the melting range of an alloy of metals is defined as the temperature or range of temperatures at which solid and liquid forms of the indium or alloy are in equilibrium. The alloys typically do not melt entirely at a single temperature but will melt gradually over a fairly wide temperature range.	105
45	The multilayer composites of the present invention are suitably prepared by any conventional method for making multilayer metal/organic polymer composites wherein the layers of metal and polymer adhere to each other. For example, the metal may be applied as a coating by a conventional metallization technique such as an electroless process described by F. A. Lowenheim in "Metal Coatings of Plastics", Noyes Data Corporation, (1970), by Pinter, S. H. et al., <i>Plastics: Surface and Finish</i> , Daniel Davey & Company, Inc., 172-186 (1971) or in U.S Patent No. 2,464,143. An especially preferred metallization technique in the practice of this invention is a vacuum deposition technique wherein the metal is vacuum evaporated and then deposited onto the polymer layer as described by William Goldie in <i>Metallic Coating of Plastics</i> , Vol. 1, Electrochemical Publications Limited, Chap. 12 (1968). Another preferred metallization technique includes sputter coating as described in Chapter 13 of Goldie, <i>supra</i> . Also suitable but less preferred metallization techniques include electroplating and ion plating. In addition, the multilayer composite can be formed by lamination of	110
50		115
55		120
60		125
65		130

metal foil to the polymer layer including extrusion coating of the polymer layer onto a metal foil.

In the formation of a multilayer composite wherein the polymer layer comprises a fairly polar polymer such as polycarbonate, polyester, polyvinyl halide or polyvinylidene halide, polyvinyl alcohol, acrylic polymers and other known polar polymers, it is generally not necessary to pretreat the polymer layer prior to application of the metal layer. However, when relatively non-polar polymers, e.g., polystyrene or polyethylene are to be employed, it is often desirable to treat the surface of the polymer layers sufficiently to enhance bonding between the metal and the polymer. Such pretreatments can include gas phase sulfonation as described in U.S. Patent No. 3,625,751 to Walles and especially the procedure described in Lindblom et al. in U.S. Patent No. 3,686,018. Other suitable methods for pretreating the polymer include, for example, corona discharge, flame treatment, or liquid phase sulfonation. Alternatively, the polymer layer may be coated with an adhesive, such as an ethylene/acrylic acid copolymer, and ethylene/vinyl acetate copolymer or similar adhesives, commonly employed in bonding metal layers to relatively nonpolar organic polymer layers.

The quantity of thickness of the soft metal layer in the multilayer composite should be such that the soft metal layer forms an essentially continuous film over the desired surface of the polymer layer and thereby provides a highly reflective surface, high barrier to vapor transmission or electroconductivity as the desired end use requires. Preferably, the thickness of the metal layer is in the range from 0.002 to 100 micrometers, more preferably from 0.01 to 100 micrometers and most preferably from 0.01 to 1 micrometer.

While the soft metal layer may be applied to either or both sides of the polymer layer(s), it is generally desirable to apply it to only one surface of the polymer layer. Accordingly, in a shaped article as shown in the drawing, the polymer layer provides protection against abrasion of the soft metal layer which would cause degradation of the highly reflective character of the article. It is understood, however, that when the soft metal layer is applied to the surface of the polymer layer which will be exposed in the final article, such exposed soft metal layer can be protected by coating with some other adherent material. Examples of such materials suitably employed as protective coatings for the soft metal layer include, for example, polycarbonates such as those derived from bisphenol-A and/or phenol-phthalein, polyesters such as polyethylene

terephthalate, acrylic polymers such as poly(methyl methacrylate), vinylidene chloride copolymers, polyepoxides, alkyd resins, or polyurethanes. An exemplary method for overcoating the metal layer is described in U.S. Patent No. 3,916,048 wherein the protective polymer in the form of a latex is applied to the metal layer and dried to form a continuous film at a temperature below the heat distortion point of the polymer layer. By following this technique it is possible to form the metal organic polymer composite before or after application of the protective coating. In cases wherein high barrier characteristics are desirable, it will generally be desirable to overcoat the soft metal layer with a barrier polymer such as a vinylidene chloride polymer/vinylidene chloride copolymer as described in U.S. Patent No. 3,916,048.

Following adherence of the soft metal layer to the polymer layer, the multilayer composite is formed by a conventional forming process, e.g., thermoforming or solid phase forming, to the desired shape. Preferably, the forming process is a conventional thermoforming process for shaping sheet stock which process is normally carried out at temperatures from about the second order transition temperature (Tg) of the polymer up to and including temperatures at or above the melting point of the polymer provided that the polymer has sufficient melt strength to undergo the forming operation without rupturing. Exemplary thermoforming processes include, for example, differential air pressure thermoforming, match dye thermoforming, vacuum forming, plug assist-vacuum forming, draw forming, impact forming, rubber pad forming, hydroforming, or drape molding. Since most thermoplastic polymers preferably employed in the practice of this invention have melting points less than 200°C (473°K), it is generally advantageous to thermoform the composite at a temperature from 25°C (298°K) to 200°C (473°K), most preferably from 90°C (363°K) to 180°C (453°K). Alternatively, the composite may be formed by solid phase forming which is carried out at temperatures below the melting point of the polymer. Exemplary solid phase forming methods include cold rolling, impact extrusion, forging, forward extrusion, cold heading, and rubber-pad forming, e.g., as such methods are further described by P. M. Coffman in *Soc. Plas. Eng. Journal*, Vol. 25, Jan., 1969 (50-54) and *Soc. Auto. Eng. Journal*, Vol. 76, No. 6, 36-41 (1968).

In the forming operation performed herein, the entire composite or a portion thereof is formed or shaped in a manner such that at least a portion of the composite undergoes a cumulative surface dimensional

- change of at least 20 percent, advantageously at least 30 percent. By cumulative surface dimensional change is meant the combined change of length and width wherein a 5 decrease as well as an increase in a particular dimension is treated as a positive change. Further, only one or both surface dimensions may be changed in the forming operation. Techniques for observing surface 10 dimensional changes are described by A. Nadai in *Plasticity*, McGraw-Hill (1931). Preferably, the composite or a portion thereof is extended (stretched) to an area which is at least 30 percent greater than its 15 original area, more preferably from 50 to 300 percent, most preferably from 150 to 300 percent. When only a portion of the composite is extended, it is that portion being extended which undergoes the 20 aforementioned increase in area. An example of such portion extension or stretching is in the forming of an automobile bumper, a rimmed cup, blister package, and certain reflectors. While the portion may be as 25 small as 1 mm², it is usually larger than 1 cm² and preferably greater than 50 cm². The actual degree of extension, of course, will vary with the intended end use.
- Following the forming operation, the 30 formed composite may be utilized without further fabrication, as is the case for most packaging and electroconductive applications. In these applications the formed multilayer composite can be used, for example, as tubs or similar deep drawn containers for various oxygen sensitive foods as described herein, as packaging films, or as printed circuit stock for electrical and electronic equipment. In such applications, if 35 the soft metal layer is not protected on both sides by the polymer layer and/or a protective polymer coating layer as described hereinbefore, it is desirable to coat the soft metal layer with a protective coating as 40 described hereinbefore.
- In addition to the foregoing uses, a 45 formed composite generally defining a cavity as shown in the drawing is reinforced by filling the enclosed or partially enclosed cavity with a reinforcing material. Alternatively, the reinforcing material may be 50 adhered to the surface of the composite outermost from the cavity or concave shape as in the case of the reflector for an automobile headlamp. The type of reinforcing material employed is not particularly critical. For example, the material may be 55 metal such as steel, wood, stone, concrete or plastics, with plastics materials comprising natural and/or synthetic organic polymers being preferred. The reinforcing polymeric filler materials of particular interest may be foamed or nonfoamed, rigid or flexible, elastomeric or non-elastomeric. 60 They may be pure (non-filled) or filled with, 65 for example, pigments, stabilizers, or reinforcing fibers such as glass fibers, or fillers. They may be blends of polymers which may contain crosslinking components. 70 Examples of suitable rigid polymeric materials include, for example, polyurethane, polystyrene, epoxy polymers, polyvinyl chloride, polyvinyl acetate, silicone polymers, cellulosic polymers, acrylic polymers, saturated polyesters and unsaturated polyesters, or asphalt. Of these materials the polyurethanes are generally preferred. Additional examples of such rigid materials, particularly in the form of foams and methods for preparing the same, are more completely described in U.S. Patent No. 3,703,571. The rigid polymers and rigid polymer foams are particularly useful in the fabrication of articles which are not exposed to significant amounts of impact. 75
- In the production of articles such as bumpers and external trim for automobiles and other vehicles of transportation that are exposed to impact, it is desirable to employ an elastomeric polymer, preferably in the form of a foam, as the reinforcing material. Examples of such elastomeric polymers include, for example, elastomeric polyurethanes, rubbery styrene/butadiene copolymers, polybutadiene rubber, natural rubber, ethylene polymers, particularly ethylene/propylene copolymer rubber. Such elastomeric polymers, whether solid or foamed, and methods for their preparation are well known to those skilled in the art and therefore will not be discussed in greater detail here. Other suitable reinforcing polymeric materials include polyethylene foam, chlorinated polyethylene or blends of two or more of the aforementioned reinforcing materials. 90
- The reinforcing material is readily cast onto the shaped multilayered composite by any of a wide variety of casting techniques. For example, a reinforcing material may be applied by foamed-in-place or pour-in-place techniques as well as spray applications, slush castings or rotational casting application. Exemplary methods are described in 95 more detail in U.S. Patent No. 3,414,456. It is desirable that the conditions of the casting technique be employed such that the formed composite does not deform during casting, foaming, and/or curing steps which may be employed. However, if such deforming conditions are employed at this time, a support mold for the thermoformed composite is 100 required. 105
- The following examples are given to 110 illustrate some specific embodiments of the invention and should not be construed as limiting the scope thereof. In the following examples, all parts and percentages are by weight unless otherwise indicated. 115
- 120
- 125

Example 1
Metallization

5 A rectangular section (27.94 cm \times 12.7 cm) of polystyrene film having a thickness of 127 micrometers and sulfonated to a degree sufficient to render the polystyrene water wettable is washed with distilled water and dried at 60°C for approximately one-half hour. A tungsten wire basket situated in a 10 vacuumizable bell jar and electrically attached to a filament control of a 5 kilovolt electron beam power supply is loaded with an indium pellet (0.1 g) and the dried polystyrene film is placed in the jar above the filament. The film is configured to the 15 shape of the partial cylinder having a radius of about 12.7 cm by taping the film to a rigid metal sheet of that configuration. The configured film is positioned in the bell jar space such that the axis of the cylinder is proximate to the filament in order to achieve a 20 fairly uniform thickness of the metal to be deposited. The bell jar is closed and the system is evacuated to a pressure of 3×10^{-5} mm Hg. The electrical current to the 25 filament is turned on and adjusted to a nominal current of 0.8 amps and maintained there for 30 seconds and then turned off for 1 minute. The same cycle is repeated and 30 subsequently the bell jar is opened to atmospheric pressure.

Thermoforming

35 The metallized polystyrene film (wherein the metal layer has a thickness of approximately 0.2 micrometer) is cut into a segment of approximately 12.7 cm \times 12.7 cm. The segment is clamped into a thermal forming cup mold having a chamber diameter of 9.5 cm and a mold temperature of 93.3°C (366.3°F). Air is supplied through a 40 connecting air line to the side of the mold facing the metallic layer of the film in an amount sufficient to apply a load of 15 psig (2.09 Kg/cm²). As a result, the sample is drawn to 45 a depth of 2.14 centimeters and withdrawn from the mold. The thermoformed sample is observed to have a brilliant, highly reflective surface when viewed through the polystyrene film layer. The surface is electrically 50 conductive from the edge of the thermoformed metallized film to the center.

Comparative Sample

55 For purposes of comparison, a second, similar strip of polystyrene film is metallized in the manner described hereinbefore except that aluminum is substituted for the indium and the deposition conditions are 60 changed to 1 amp for 1.25 minutes. The resulting metallized film is molded by the drawing procedures set forth hereinbefore except that an air pressure of only 11 psig is employed to produce significantly less stretching such that the total depth of the

molded article is only 1.9 centimeters. The resulting sample is not brilliantly reflective and actually exhibits rather diffused reflection. This sample also did not exhibit electroconductivity from the edge to the center of the sample. 70

Example 2

75 A rectangular section (33.02 cm \times 55.88 cm) of polycarbonate film wherein the polycarbonate is derived from bisphenol A and phosgene and the film has a thickness of 127 micrometers is placed in a bell jar equipped as in Example 1. A 0.5-g pellet of an alloy of 50 percent tin, 30 percent bismuth and 20 percent copper is evaporated from the tungsten wire basket onto the polycarbonate film. The electrical current to the basket is controlled so that complete evaporation of the alloy occurs in two minutes. A segment (12.7 cm \times 12.7 cm) of the metallized polycarbonate film is cut from the sample and clamped into a thermoforming mold having a mold temperature of 137.8°C (410.8°F). Air is supplied to the metal layer surface at sufficient pressure to apply a load of 15 psig (2.09 Kg/cm²). A sample is thereby thermoformed to a depth of 2.5 centimeters and then withdrawn from the mold. The sample is observed to have a brilliant, highly reflective surface when viewed through the polycarbonate film. The metallic surface is electrically conductive from the edge of the sample to the center of the sample. 90

100 In accordance with the foregoing procedure of this example, several other alloys included within the scope of this invention are deposited on the polycarbonate film and subsequently thermoformed into cup-like structures that have brilliant, highly reflective surfaces when viewed through the polycarbonate film and are electrically conductive from the edge to center. These alloys are as follows: 0.7 gram of an alloy of 105 80 percent tin, 15 percent bismuth and 5 percent copper; 0.6 gram of an alloy of 75 percent tin, 20 percent bismuth and 5 percent silver; and 0.6 gram of an alloy of 75 percent tin and 25 percent silver. 110

115 For purposes of comparison, other metals and alloys outside the scope of this invention are similarly deposited on polycarbonate film and subsequently thermoformed into cup-like structures in the manner described hereinbefore which exhibited a loss of electrical conductivity in specular reflectance. These metals and alloys include stainless steel, an alloy of 50 percent tin and 50 percent copper, an alloy of 85 percent aluminum and 15 percent magnesium, and metals such as aluminum, tin, copper, silver and chromium which are deposited separately on the polycarbonate. 120

125 While it is observed that the alloys of tin 130

and bismuth and alloys of zinc and cadmium sometimes exhibited a moderate loss of specular reflectance and electroconductivity when applied to polycarbonate film and thermoformed at temperatures of 137.8°C (410.8°K), such moderate losses of reflectance and of electrical conductivity are avoided by incorporating a small percentage (preferably from about 2 to about 10 percent) of silver, copper and/or one or more other metals melting above 450°C (723°K) in the alloy or by depositing a very thin coat (<50 Å of silver or other higher melting (>450°C) (>723°K) metal or metal alloy on the polycarbonate film prior to deposition of the alloy.

As an example of such a modified metallization technique, an 0.01-g pellet of silver is deposited on a polycarbonate film by the vacuum metallization technique and then a 0.5-g pellet of an alloy of 50 percent zinc, and 50 percent cadmium is deposited on the silver polycarbonate film. When the resultant metallized film is thermoformed by the aforementioned procedure to produce a cup having a depth of 3.5 centimeters, the resultant cup is highly reflective and electroconductive.

30 *Example 3*

A thermoformable, amorphous polyethylene terephthalate film (polyester film) having a thickness of about 25 micrometers is surface activated by passing the film through a flame in accordance with a conventional flame treatment technique. A 1.2-g pellet of an alloy of 55 percent tin, 35 percent bismuth and 10 percent silver is deposited on the flame-treated surface of the polyester film in accordance with the vacuum deposition technique set forth in the preceding examples. The metallized film is then thermoformed into a cup-like structure at a mold temperature of 77°C (350°K). The resulting molded part is highly reflective and electroconductive.

45 *Example 4*

50 A polystyrene film having a thickness of about 13 micrometers is flame treated as in the preceding example and the sample is placed in the bell jar which is evacuated. The evacuated jar is backfilled with a small amount of argon gas and a highly negative voltage charge is applied to one connection of the filament basket, the other connection being open and the base plate of the vacuum system being grounded. This application of highly negative voltage set up a glow discharge current of 10 milliamps at 0.7 kilovolts and an argon pressure of 0.1 mm Hg. This glow discharge is continued for about 1 minute, and the high voltage is then disconnected. A 0.4-g pellet of indium is then vacuum deposited on the treated polys-

tyrene film by the aforementioned vacuum depositing procedure.

5 A segment (12.7 cm × 12.7 cm) of the metallized polystyrene sample is coated with a latex of a vinylidene chloride/acrylonitrile/sulfoethyl methacrylate (90/8/2) terpolymer by applying a 50 percent solids latex of the terpolymer to the metal layer to produce a film having a wet thickness of about 5 micrometers. The latex film is dried for 2 hours at 65°C (338°K) and the resulting dried metallized composite is subsequently thermoformed to a cup having a depth of 3 centimeters. The metal layer is highly reflective and visually continuous. The thermoformed composite when tested for barrier exhibits an oxygen transmission rate of 0.02 cc/100 in² (645 cm²)/24 hours/atm at 25°C (298°K). Oxygen transmission rate is determined according to the dynamic gas chromatographic method reported by T. L. Caskey in *Modern Plastics*, December, 1967.

10 A similar polystyrene film metallized with aluminum, coated with the terpolymer latex and thermoformed to a cup depth of 2.5 centimeters is observed to have a visually discontinuous metal film and an oxygen transmission rate of greater than 5 cc/100 in² (645 cm²)/24 hours/atm.

70

75

80

85

90

95

30 *Example 5*

100 A section (12.7 cm × 12.7 cm) of the polycarbonate film of Example 2 is placed on a steel plate. Fifty grams of indium is melted in a crucible and the molten metal is poured onto the polycarbonate film to provide a coating thickness of about 0.158 centimeter over a 7.62 cm diameter circular portion of the section of polycarbonate film. The resulting metal/polymer composite is thermoformed by the procedure of the foregoing examples to produce a cup having a depth of 2 centimeters. The cup is observed to have a brilliant reflective surface when viewed through the polycarbonate film and is electrically conductive from the edge to the center of the thermoformed cup.

105

110

115

120

125

115 In the foregoing examples, thermoforming the composites to a cup depth of 2 centimeters is comparable to a biaxial stretching sufficient to increase the area of the thermoformed cup to 40 percent greater than the metallized film prior to thermoforming.

120 *Example 6*

125 Following the procedure of Example 2, a bilayer composite is prepared using the polycarbonate film of Example 2 and an alloy of 50 percent tin, 30 percent bismuth and 20 percent copper. A portion (2.54 cm × 15.24 cm) of the bilayer composite is tested for adhesion by application and re-

130

- removal of a (1.91 cm \times 5.08 cm) portion of pressure pressure sensitive adhesive tape from the alloy layer (1,000 Å thickness). No removal of the alloy layer is observed.
- 5 For purposes of comparison, another portion of the polycarbonate film is coated with aluminum using a similar procedure. Upon testing the aluminized film (having an aluminum layer thickness of 1,000 Å) for adhesion in the foregoing manner, the metal appears to be completely removed in the region contacted by the tape. 70
- 10
- 15 *Example 7*
Another portion (2.54 cm \times 15.24 cm) of the alloy coated film of Example 6 is heated to 130°C (403°K) for 5 minutes. The metal film is then scribed with a razor blade and a pressure sensitive adhesive tape is applied to cover a portion of the scribe marks. A drop of water is applied to the metal tape interface so as to wet the exposed (non-taped) scribe marks. The sample is soaked in this manner for about one minute, and the tape is then slowly pulled off the sample. No removal of alloy is observed. 80
- 20
- 25
- 30 For purposes of comparison, a portion of the aluminized polycarbonate from the comparative sample of Example 6 is heated according to the procedure of Example 7. The sample is scribed, tape tested and wetted with water according to the procedure of Example 7. Upon removal of the tape, the aluminum coating is peeled cleanly from the polycarbonate film. 90
- 35
- 40 *Example 8*
Following Examples 6 and 7 except that a polyethylene terephthalate film is substituted for the polycarbonate film, alloy/polymer composites and aluminum/polymer composites are prepared and tested for adhesion as in Examples 6 and 7. The alloy/polymer composites passed both tests whereas the aluminum polymer composites failed both tests. 100
- 45
- 50 *Example 9*
Following Examples 6 and 7 except that an alloy of 75 percent tin and 25 percent silver is substituted for the alloy used in Examples 6 and 7, an alloy/polycarbonate composite is prepared and tested for adhesion. The composite passed both tests. 105
- 55
- 60 When the polycarbonate film is metallized with tin, silver or an alloy, 99 percent tin and 1 percent silver and tested for adhesion as in Examples 6 and 7, the metallized composites failed the adhesion tests. 110
- 65
- 70 *Example 10*
Following the procedure of Example 2, a portion (15.24 cm \times 60.96 cm) of polyethylene film is coated with about 0.2 g of an alloy of 80 percent tin, 14 percent bismuth and 6 percent copper. When a (15.24 cm \times 15.24 cm) portion is tested for barrier to oxygen, it exhibits an oxygen transmission rate of ~1.8 cc/24 hrs. 75
- 75
- 80
- 85
- 90
- 95
- 100
- 105
- 110
- 115
- 120
- 125
- 130
- Similar results are obtained when polyethylene film or other polymer film such as a vinylidene chloride copolymer film is metallized with other alloys of from 50 to 95 percent tin, 5 to 50 percent of at least one of bismuth, antimony and zinc and up to 25 percent of at least one of copper, silver and nickel.
- When a similar polyethylene film portion coated with aluminum is similarly tested for oxygen barrier, an oxygen transmission rate of ~36 cc/24 hrs is observed. The uncoated polyethylene film exhibits an oxygen transmission rate of ~180 cc/24 hrs.
- Example 11*
Following the procedure of Example 2, a bilayer composite is prepared using the polycarbonate film of Example 2 and an alloy of 84 percent tin, 12 percent bismuth and 4 percent copper. A sample (12.7 cm \times 12.7 cm) of this composite is tested for electrical resistance (ER) by attaching two electrical contacts to the sample and ER is found to be 0.7 ohm/square. The sample is shaped into a cup to a depth of 2 cm as in Example 2, and the ER is again measured by attaching the electrical contacts to the sample in the formed area. The ER is found to be 1 ohm/square.
- For purposes of comparison, a bilayer composite is prepared as in Example 11 except that aluminum is substituted for the metal alloy. As in Example 11, a sample (12.7 cm \times 12.7 cm) of the aluminum composite is tested for ER, formed into a cup shape and retested for ER. The results of these tests are as follows: ER before forming is 0.7 ohm/square, ER after forming is >1000 ohms/square. Results similar to those obtained for the aluminum composite are obtained if silver is substituted for aluminum in preparing and testing a bilayer composite by the procedure of Example 11.
- According to a further aspect of the present invention the soft metal of the metal/organic polymer composite is selected from alloys of from 25 to 90 weight percent tin, from 8 to 60 weight percent bismuth and from 1 to 25 weight percent of at least one of copper, silver, nickel, magnesium, gold, iron, chromium and manganese, providing that one of the metals tin or bismuth is present in an amount of at least 50 weight percent.
- WHAT WE CLAIM IS:-**
1. A formable metal/organic polymer composite comprising a layer of a normally solid thermoplastic polymer (as hereinbefore defined) and a layer of a normally solid

- soft metal intimately adhered to at least one surface of the polymer layer, said soft metal melting at a temperature or over a range of temperatures that is from 80 to 135 percent 5 of the forming temperature of the thermoplastic polymer, said temperatures being in degrees K, and being indium or an alloy of two or more metals, other than a lead alloy, comprising at least 50 weight percent of a first metal and at least 5 weight percent of at 10 least one second metal, the said composite being capable, when subjected to a forming operation, of undergoing a cumulative surface dimensional change of at least 20 percent.
2. A composite as claimed in claim 1 wherein both the first metal and the second metal(s) have melting points below 450°(723°K).
3. A composite as claimed in claim 2 wherein the alloy also contains at least 0.1 weight percent of a metal having a melting point above 450°C (723°K).
4. A composite as claimed in any one of 25 the preceding claims wherein the alloy has a solidus temperature of less than 650°K and contains at least 60 weight percent of indium, bismuth, tin, zinc, cadmium or antimony.
5. A composite as claimed in any one of 30 the preceding claims wherein the alloy does not contain more than 90 weight percent of any one metal.
6. A composite as claimed in any one of 35 the preceding claims wherein the alloy does not contain more than 80 weight percent of any one metal and has a solidus temperature of less than 548°K.
7. A composite as claimed in claim 1 40 wherein the alloy contains from 85 to 95 weight percent of indium, bismuth, tin, zinc, cadmium or antimony or a mixture thereof providing that in any such mixture one of the metals is present in an amount of at least 50 weight percent and from 5 to 15 weight percent of copper, silver, gold, nickel, magnesium or aluminium, or a mixture thereof providing that in any such mixture one of the metals is present in an amount of 45 at least 5 weight percent.
8. A composite as claimed in claim 1 50 wherein the soft metal is selected from alloys of from 25 to 90 weight percent tin, from 8 to 60 weight percent bismuth and from 1 to 25 weight percent of at least one of copper, silver, nickel, magnesium, gold, iron, chromium and manganese, providing that one of the metals tin or bismuth is present in an amount of at least 50 weight percent.
9. A composite as claimed in claim 1 55 wherein the soft metal is an alloy selected from the following alloys comprising metals in the indicated weight percentages (i) 50 percent tin, 30 percent bismuth, 20 percent
- copper; (ii) 80 percent tin, 15 percent bismuth, 5 percent copper; (iii) 75 percent tin, 20 percent copper, 5 percent silver; (iv) 75 percent tin, 25 percent silver; (v) 55 percent tin, 35 percent bismuth; 10 percent silver; and (vi) 84 percent tin, 12 percent bismuth, 4 percent copper. 70
10. A composite as claimed in any one of the preceding claims wherein the polymer is polystyrene, a styrene/acrylonitrile copolymer, a copolymer containing polymerized styrene, acrylonitrile and butadiene, a styrene/butadiene copolymer, a rubber modified styrene polymer, a styrene/maleic anhydride copolymer, a polymer of monovinylidene aromatic carbocyclic monomer; a polycarbonate; a polyester; an acrylic resin; a polyacetylene resin; a nitrile resin and another polymer of an α,β -ethylenically unsaturated nitrile; a polyamide; a polyolefin; a polyvinyl halide; a polyurethane; a polyallomeric; a polyphenylene oxide; and a polymer of a fluorinated olefin. 75
11. A composite as claimed in claim 9 wherein the polymer is selected from a polycarbonate made from phosgene and bisphenol A and/or phenolphthalein; polyethylene terephthalate; poly(methyl methacrylate); polyformaldehyde resin; polyacrylonitrile; an acrylonitrile/methyl methacrylate copolymer nylon; polyethylene and polypropylene; polyvinyl chloride and a vinylidene chloride homopolymer and copolymer; and polytetrafluoroethylene. 80
12. A composite as claimed in claim 1 wherein the soft metal is indium or an alloy of at least two of cadmium, indium, tin, antimony, bismuth, magnesium, aluminium, zinc, copper and silver, and the thermoplastic polymer is a polycarbonate, a polyester, an acrylic resin, a monovinylidene aromatic polymer, a polymer of a vinyl halide or a vinylidene halide, or a polyacetal. 85
13. A composite as claimed in claim 1 wherein the thermoplastic polymer is a polycarbonate, a polyester, or a monovinylidene aromatic polymer and the soft metal is 90
- 1) indium;
 - 2) an alloy of 55 percent tin, 35 percent bismuth, and 10 percent silver;
 - 3) an alloy of 50 percent zinc and 50 percent cadmium;
 - 4) An alloy of 80 percent tin, 15 percent bismuth and 5 percent copper;
 - 5) an alloy of 75 percent tin, 20 percent bismuth and 5 percent silver;
 - 6) an alloy of 75 percent tin and 25 percent silver; or
 - 7) an alloy of 50 percent tin, 30 percent bismuth and 20 percent copper;
- said percentages being by weight. 110
14. A composite as claimed in claim 1 115
- 120
- 125
- 130

- wherein the polymer is polyethylene or a vinylidene chloride copolymer and the soft metal is an alloy containing from 50 to 95 weight percent tin, from 5 to 50 weight percent of at least one of bismuth, antimony and zinc and up to about 25 weight percent of copper, silver and nickel.
15. A composite as claimed in any one of the preceding claims wherein the soft metal layer has a thickness of from 0.01 to 1 micrometer.
16. A composite as claimed in any one of the preceding claims wherein the polymer layer contains one or more dyes, light stabilizers, reinforcement fillers and fibers, pigments, or carbon black.
17. A composite as claimed in claim 1 substantially as hereinbefore described in any one of the Examples.
20. 18. A method of making a metal/organic polymer composite as claimed in claim 1, which method comprises intimately adhering together a layer of a normally solid, soft metal as defined in claim 1 and at least one surface of a layer or a normally solid, formable thermoplastic polymer (as hereinbefore defined).
19. A method as claimed in claim 18 wherein the soft metal is applied to the polymer by vacuum deposition, sputter coating, or electroless deposition.
25. 20. A method as claimed in claim 18 substantially as hereinbefore described in any one of the Examples.
30. 21. A metal/organic polymer composite which has been made by a method as claimed in any one of claims 18 to 20.
35. 22. A method of making a formed metal/organic polymer composite, which method comprises subjecting a metal/organic polymer composite as claimed in any one of claims 1 to 18, or claim 21, to a forming operation during which at least a portion of the composite is modified by its undergoing a cumulative surface dimensional change of at least 20 percent.
40. 23. A method as claimed in claim 21 wherein the portion undergoes a cumulative surface dimensional change of at least 30 percent.
45. 24. A method as claimed in claim 23 wherein the change is from 50 to 300 percent.
50. 25. A method as claimed in claim 24 wherein the change is from 150 to 300 percent.
55. 26. A method as claimed in any one of claims 22 to 25 in which the forming operation is cold drawing, vacuum drawing, drape molding, pressure thermoforming or scrapless thermoforming or scrapless thermoforming.
60. 27. A method as claimed in claim 22 substantially as hereinbefore described in any one of the Examples.
65. 28. A formed metal/organic polymer composite which has been made by a method as claimed in any one of claims 22 to 27.
29. A formed composite as claimed in claim 28 wherein a polymer layer is adhered to each of the surfaces of the soft metal layer.
30. A shaped article comprising a formed composite as claimed in claim 28 or claim 29.
31. Packaging, including packaging for oxygen-sensitive foods, and printed circuit stock for electrical and electronic equipment comprising a formed composite as claimed in claim 28 or claim 29.
32. A shaped article comprising (1) a formed composite as claimed in claim 28 or claim 29 and (2) a reinforcing material in intimate contact with at least one surface of the formed composite.
33. A shaped article as claimed in claim 32 in which the reinforcing material is a rigid polymeric material such as polyurethane, polystyrene, an epoxy polymer, polyvinyl chloride, polyvinyl acetate, a silicone polymer, a cellulosic polymer, an acrylic polymer, a saturated polyester, an unsaturated polyester, or asphalt.
34. A shaped article as claimed in claim 32 in which the reinforcing material is an electromeric polymer such as an elastomeric polyurethane, a rubber styrene/butadiene copolymer, a polybutadiene rubber, natural rubber, or an ethylene polymer, particularly an ethylene/propylene copolymer rubber.
35. Bumpers and external trim for automobiles and other vehicles of transportation which are shaped articles as claimed in claim 34.

BOULT, WADE & TENNANT,
27 Furnival Street,
London, EC4A 1PQ.

Printed for Her Majesty's Stationery Office,
by Croydon Printing Company Limited, Croydon, Surrey, 1981.
Published by The Patent Office, 25 Southampton Buildings,
London, WC2A 1AY, from which copies may be obtained.

